

General Description

The CMSC012N06 is designed to provide a high efficiency synchronous buck power stage with optimal layout and board space utilization. This device is well suited for use in compact DC/DC converter applications.

Features

- N-Channel MOSFET
- Low Gate Charge
- Surface Mount Package
- RoHS Compliant

Absolute Maximum Ratings

Product Summary

| BVDSS | RDSON | ID |
|-------|-------|-----|
| 60V | 11mΩ | 20A |

N-Channel Enhancement Mode MOSET

Applications

CMSC012N06

- High efficiency power supply
- Secondary synchronous rectifier

DFN-8 3x3 Pin Configuration



DFN-8 3*3

012N06

| Symbol | Parameter | Rating | Units | |
|--------------------------------------|---|------------|-------|--|
| V _{DS} | Drain-Source Voltage | 60 | V | |
| V _{GS} | Gate-Source Voltage | ±20 | V | |
| I _D @T _C =25℃ | Continuous Drain Current | 20 | Δ | |
| I _D @T _C =100℃ | | 16 | ~~~~ | |
| I _{DM} | Pulsed Drain Current | 60 | А | |
| EAS | Single Pulse Avalanche Energy | 45 | mJ | |
| P _D @T _C =25℃ | Total Power Dissipation | 50 | W | |
| T _{STG} | Storage Temperature Range | -55 to 150 | °C | |
| TJ | Operating Junction Temperature Range -55 to 150 | | °C | |

Thermal Characteristics

| Symbol | Parameter | Тур. | Max. | Unit |
|------------------|---|------|------|------|
| R _{0JA} | Thermal Resistance Junction-ambient(Steady-State) | | 60 | °C/W |
| R _{θJC} | Thermal Resistance Junction -Case(Steady-State) | | 2.5 | °C/W |



CMSC012N06

N-Channel Enhancement Mode MOSFET

Electrical Characteristics (T_J=25 $^\circ\!\!\mathbb{C}$, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|---------------------|-----------------------------------|---|------|------|------|------|
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V , I _D =250uA | 60 | | | V |
| Р | Static Drain-Source On-Resistance | V _{GS} =10V , I _D =20A | | | 11 | mΩ |
| RDS(ON) | | V _{GS} =4.5V , I _D =15A | | | 17.5 | |
| VGS(th) | Gate Threshold Voltage | $V_{GS}=V_{DS}$, $I_D = 250 \mu A$ | 1 | | 3 | V |
| I _{DSS} | Drain-Source Leakage Current | V _{DS} =60V , V _{GS} =0V | | | 1 | uA |
| I _{GSS} | Gate-Source Leakage Current | $V_{GS} = \pm 20V$ | | | ±100 | nA |
| gfs | Forward Transconductance | V _{DS} =10V , I _D =20A | | 15 | | S |
| Qg | Total Gate Charge | | | 26 | | nC |
| Q _{gs} | Gate-Source Charge | ─V _{DS} =30V , I _D =20A ─V _{GS} =10V - | | 11 | | |
| Q _{gd} | Gate-Drain Charge | | | 2 | | |
| T _{d(on)} | Turn-On Delay Time | V _{DS} =30V , V _{GS} =10V , R _{GEN} =3Ω I _D =20A | | 11 | | |
| Tr | Rise Time | | | 78 | | 20 |
| T _{d(off)} | Turn-Off Delay Time | | | 15 | | ns |
| T _f | Fall Time | | | 7 | | |
| C _{iss} | Input Capacitance | V _{DS} = 30V, V _{GS} =0V , f=1MHz | | 860 | | |
| Coss | Output Capacitance | | | 440 | | pF |
| Crss | Reverse Transfer Capacitance | | | 18 | | |

Diode Characteristics

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|----------------------|----------------------------------|--|------|------|------|------|
| Is | Diode continuous forward current | Vg=VD=0V , Force Current | | | 20 | А |
| I _{S,pulse} | Diode pulse current | | | | 60 | А |
| V _{SD} | Diode Forward Voltage | V _{GS} =0V , I _F =28A , Tj=25℃ | | | 1 | V |

This product has been designed and qualified for the counsumer market.

Cmos assumes no liability for customers' product design or applications. Cmos reserver the right to improve product design ,functions and reliability wihtout notice.